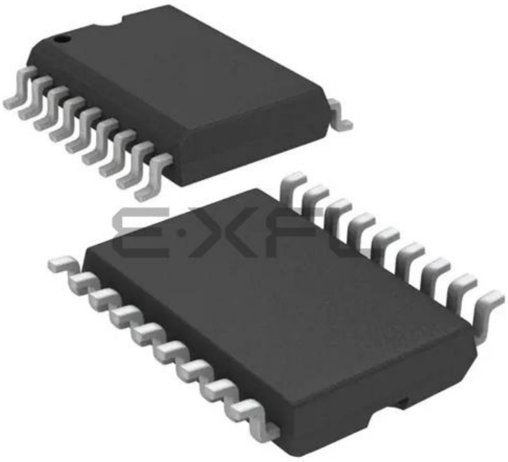

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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	16
Program Memory Size	3.5KB (2K x 14)
Program Memory Type	FLASH
EEPROM Size	128 x 8
RAM Size	224 x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	18-SOIC (0.295", 7.50mm Width)
Supplier Device Package	18-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f628-04i-so

TABLE 2-1: PIC16F62X PINOUT DESCRIPTION (CONTINUED)

Name	Function	Input Type	Output Type	Description
RB4/PGM	RB4	TTL	CMOS	Bi-directional I/O port. Can be software programmed for internal weak pull-up.
	PGM	ST	—	Low voltage programming input pin. Interrupt-on-pin change. When low voltage programming is enabled, the interrupt-on-pin change and weak pull-up resistor are disabled.
RB5	RB5	TTL	CMOS	Bi-directional I/O port. Interrupt-on-pin change. Can be software programmed for internal weak pull-up.
RB6/T1OSO/T1CKI/PGC	RB6	TTL	CMOS	Bi-directional I/O port. Interrupt-on-pin change. Can be software programmed for internal weak pull-up.
	T1OSO	—	XTAL	Timer1 oscillator output.
	T1CKI	ST	—	Timer1 clock input.
	PGC	ST	—	ICSP™ Programming Clock.
RB7/T1OSI/PGD	RB7	TTL	CMOS	Bi-directional I/O port. Interrupt-on-pin change. Can be software programmed for internal weak pull-up.
	T1OSI	XTAL	—	Timer1 oscillator input. Wake-up from SLEEP on pin change. Can be software programmed for internal weak pull-up.
	PGD	ST	CMOS	ICSP Data I/O
VSS	VSS	Power	—	Ground reference for logic and I/O pins
VDD	VDD	Power	—	Positive supply for logic and I/O pins

Legend: O = Output; — = Not used; TTL = TTL Input; CMOS = CMOS Output; I = Input; OD = Open Drain Output; P = Power; ST = Schmitt Trigger Input; AN = Analog

NOTES:

4.0 GENERAL DESCRIPTION

The PIC16F62X are 18-Pin FLASH-based members of the versatile PIC16CXX family of low cost, high performance, CMOS, fully static, 8-bit microcontrollers.

All PICmicro® microcontrollers employ an advanced RISC architecture. The PIC16F62X have enhanced core features, eight-level deep stack, and multiple internal and external interrupt sources. The separate instruction and data buses of the Harvard architecture allow a 14-bit wide instruction word with the separate 8-bit wide data. The two-stage instruction pipeline allows all instructions to execute in a single cycle, except for program branches (which require two cycles). A total of 35 instructions (reduced instruction set) are available. Additionally, a large register set gives some of the architectural innovations used to achieve a very high performance.

PIC16F62X microcontrollers typically achieve a 2:1 code compression and a 4:1 speed improvement over other 8-bit microcontrollers in their class.

PIC16F62X devices have special features to reduce external components, thus reducing system cost, enhancing system reliability and reducing power consumption.

The PIC16F62X has eight oscillator configurations. The single pin ER oscillator provides a low cost solution. The LP oscillator minimizes power consumption, XT is a standard crystal, INTRC is a self-contained internal oscillator. The HS is for High Speed crystals. The EC mode is for an external clock source.

The SLEEP (Power-down) mode offers power savings. The user can wake-up the chip from SLEEP through several external interrupts, internal interrupts, and RESETS.

A highly reliable Watchdog Timer with its own on-chip RC oscillator provides protection against software lock-up.

Table 4-1 shows the features of the PIC16F62X mid-range microcontroller families.

A simplified block diagram of the PIC16F62X is shown in Figure 2.1.

The PIC16F62X series fits in applications ranging from battery chargers to low power remote sensors. The FLASH technology makes customization of application programs (detection levels, pulse generation, timers, etc.) extremely fast and convenient. The small footprint packages make this microcontroller series ideal for all applications with space limitations. Low cost, low power, high performance, ease of use and I/O flexibility make the PIC16F62X very versatile.

4.1 Development Support

The PIC16F62X family is supported by a full featured macro assembler, a software simulator, an in-circuit emulator, a low cost development programmer and a full-featured programmer. A Third Party "C" compiler support tool is also available.

TABLE 4-1: PIC16F62X FAMILY OF DEVICES

		PIC16F627	PIC16F628	PIC16LF627	PIC16LF628
Clock	Maximum Frequency of Operation (MHz)	20	20	4	4
Memory	FLASH Program Memory (words)	1024	2048	1024	2048
	RAM Data Memory (bytes)	224	224	224	224
	EEPROM Data Memory (bytes)	128	128	128	128
Peripherals	Timer Module(s)	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2	TMR0, TMR1, TMR2
	Comparator(s)	2	2	2	2
	Capture/Compare/PWM modules	1	1	1	1
	Serial Communications	USART	USART	USART	USART
	Internal Voltage Reference	Yes	Yes	Yes	Yes
Features	Interrupt Sources	10	10	10	10
	I/O Pins	16	16	16	16
	Voltage Range (Volts)	3.0-5.5	3.0-5.5	2.0-5.5	2.0-5.5
	Brown-out Detect	Yes	Yes	Yes	Yes
	Packages	18-pin DIP, SOIC, 20-pin SSOP	18-pin DIP, SOIC, 20-pin SSOP	18-pin DIP, SOIC, 20-pin SSOP	18-pin DIP, SOIC, 20-pin SSOP

All PICmicro® Family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect and high I/O current capability. All PIC16F62X Family devices use serial programming with clock pin RB6 and data pin RB7.

NOTES:

FIGURE 5-4: BLOCK DIAGRAM OF RA4/T0CKI PIN

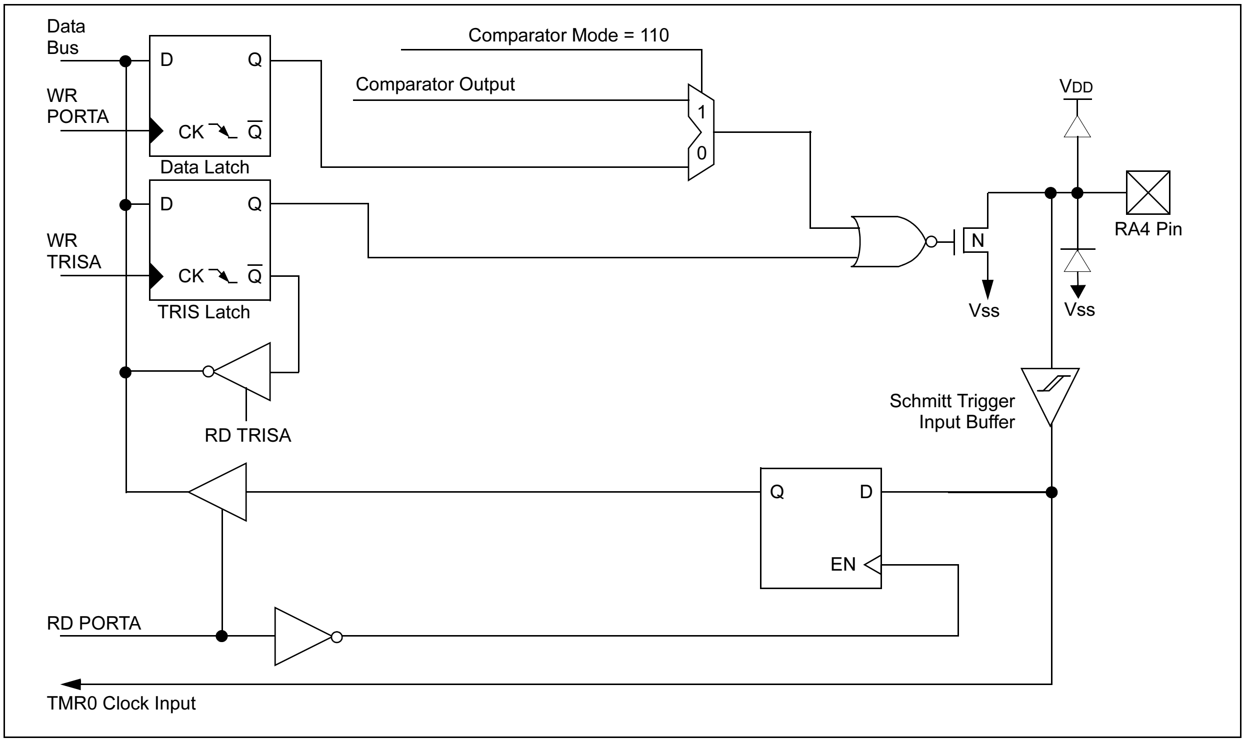


FIGURE 5-5: BLOCK DIAGRAM OF THE RA5/MCLR/VPP PIN

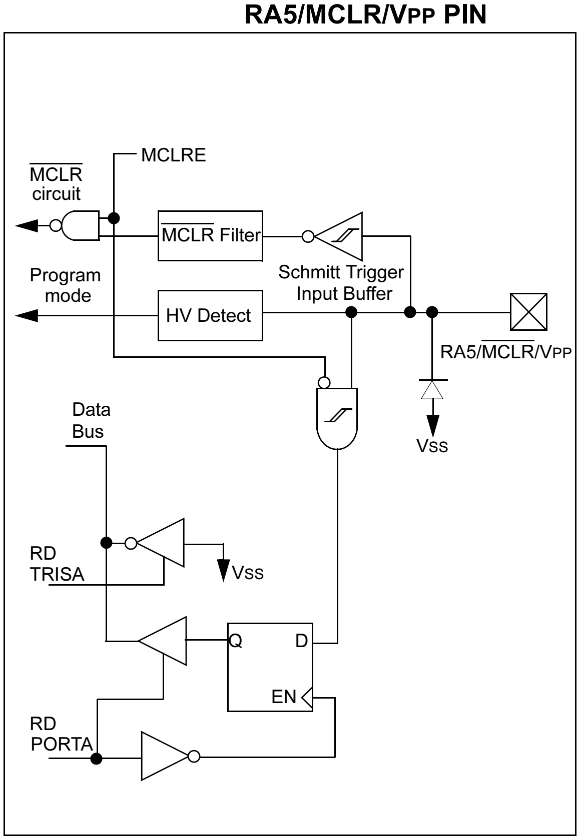
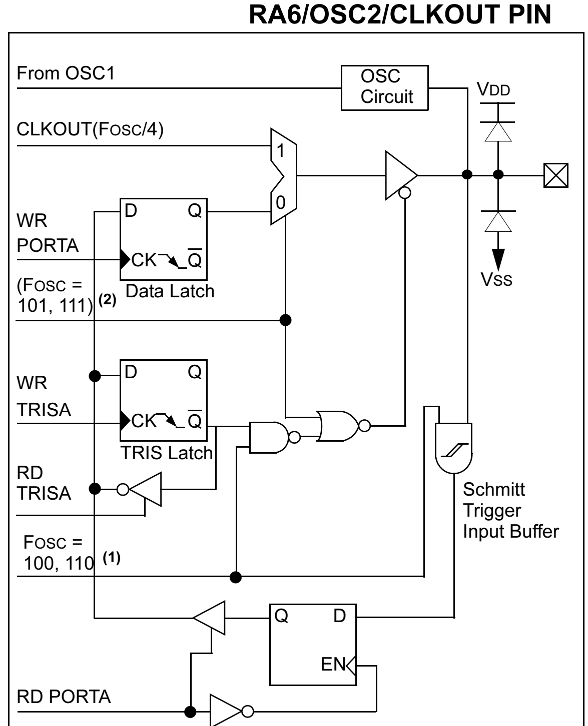


FIGURE 5-6: BLOCK DIAGRAM OF RA6/OSC2/CLKOUT PIN



Note 1: INTRC with RA6 = I/O or ER with RA6 = I/O.
2: INTRC with RA6 = CLKOUT or ER with RA6 = CLK-OUT.

7.1 Timer1 Operation in Timer Mode

Timer mode is selected by clearing the TMR1CS (T1CON<1>) bit. In this mode, the input clock to the timer is FOSC/4. The synchronize control bit $\overline{\text{T1SYNC}}$ (T1CON<2>) has no effect since the internal clock is always in sync.

7.2 Timer1 Operation in Synchronized Counter Mode

Counter mode is selected by setting bit TMR1CS. In this mode the timer increments on every rising edge of clock input on pin RB7/T1OSI when bit T1OSCEN is set or pin RB6/T1OSO/T1CKI when bit T1OSCEN is cleared.

If $\overline{\text{T1SYNC}}$ is cleared, then the external clock input is synchronized with internal phase clocks. The synchronization is done after the prescaler stage. The prescaler stage is an asynchronous ripple-counter.

In this configuration, during SLEEP mode, Timer1 will not increment even if the external clock is present, since the synchronization circuit is shut off. The prescaler however will continue to increment.

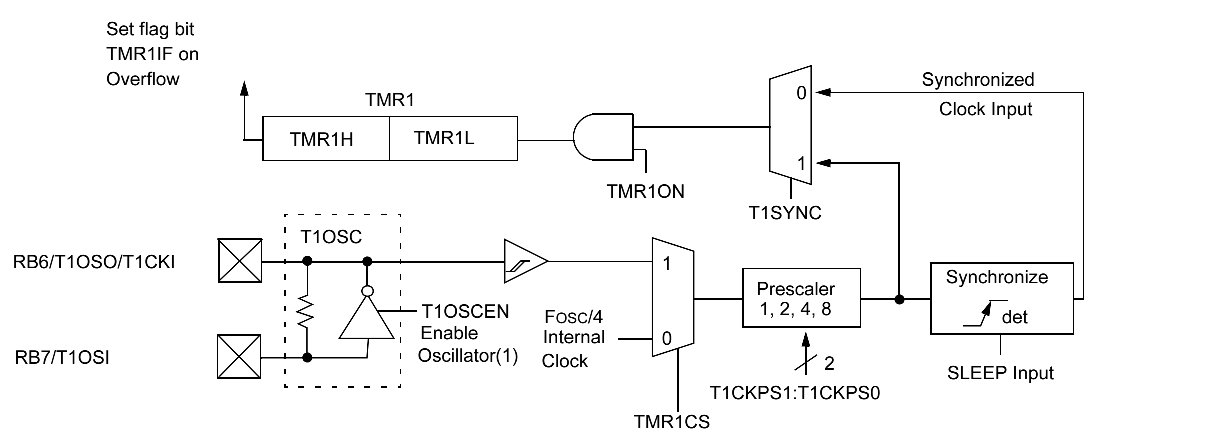
7.2.1 EXTERNAL CLOCK INPUT TIMING FOR SYNCHRONIZED COUNTER MODE

When an external clock input is used for Timer1 in Synchronized Counter mode, it must meet certain requirements. The external clock requirement is due to internal phase clock (Tosc) synchronization. Also, there is a delay in the actual incrementing of TMR1 after synchronization.

When the prescaler is 1:1, the external clock input is the same as the prescaler output. The synchronization of T1CKI with the internal phase clocks is accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the internal phase clocks. Therefore, it is necessary for T1CKI to be high for at least 2Tosc (and a small RC delay of 20 ns) and low for at least 2Tosc (and a small RC delay of 20 ns). Refer to the appropriate electrical specifications, parameters 45, 46, and 47.

When a prescaler other than 1:1 is used, the external clock input is divided by the asynchronous ripple-counter type prescaler so that the prescaler output is symmetrical. In order for the external clock to meet the sampling requirement, the ripple-counter must be taken into account. Therefore, it is necessary for T1CKI to have a period of at least 4Tosc (and a small RC delay of 40 ns) divided by the prescaler value. The only requirement on T1CKI high and low time is that they do not violate the minimum pulse width requirements of 10 ns). Refer to the appropriate electrical specifications, parameters 40, 42, 45, 46, and 47.

FIGURE 7-1: TIMER1 BLOCK DIAGRAM



Note 1: When the T1OSCEN bit is cleared, the inverter and feedback resistor are turned off. This eliminates power drain.

8.0 TIMER2 MODULE

Timer2 is an 8-bit timer with a prescaler and a postscaler. It can be used as the PWM time-base for PWM mode of the CCP module. The TMR2 register is readable and writable, and is cleared on any device RESET.

The input clock (FOSC/4) has a prescale option of 1:1, 1:4 or 1:16, selected by control bits T2CKPS1:T2CKPS0 (T2CON<1:0>).

The Timer2 module has an 8-bit Period Register PR2. Timer2 increments from 00h until it matches PR2 and then resets to 00h on the next increment cycle. PR2 is a readable and writable register. The PR2 register is initialized to FFh upon RESET.

The match output of TMR2 goes through a 4-bit postscaler (which gives a 1:1 to 1:16 scaling inclusive) to generate a TMR2 interrupt (latched in flag bit TMR2IF, (PIR1<1>)).

Timer2 can be shut off by clearing control bit TMR2ON (T2CON<2>) to minimize power consumption.

Register 8-1 shows the Timer2 Control register.

8.1 Timer2 Prescaler and Postscaler

The prescaler and postscaler counters are cleared when any of the following occurs:

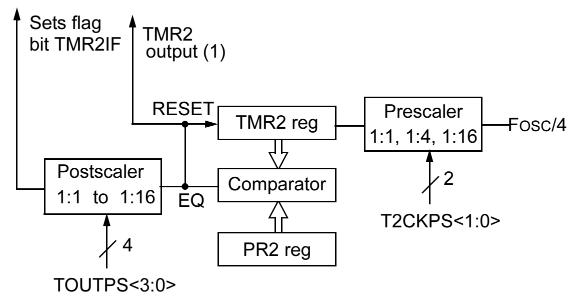
- A write to the TMR2 register
- A write to the T2CON register
- Any device RESET (Power-on Reset, $\overline{MCLR}$ Reset, Watchdog Timer Reset, or Brown-out Reset)

TMR2 is not cleared when T2CON is written.

8.2 Output of TMR2

The output of TMR2 (before the postscaler) is fed to the Synchronous Serial Port module which optionally uses it to generate shift clock.

FIGURE 8-1: TIMER2 BLOCK DIAGRAM



Note 1: TMR2 register output can be software selected by the SSP Module as a baud clock.

The code example in Example 9-1 depicts the steps required to configure the Comparator module. RA3 and RA4 are configured as digital output. RA0 and RA1 are configured as the V- inputs and RA2 as the V+ input to both comparators.

EXAMPLE 9-1: INITIALIZING COMPARATOR MODULE

```
FLAG_REG EQU        0X20
CLRF     FLAG_REG   ;Init flag register
CLRF     PORTA      ;Init PORTA
MOVF     CMCON, W   ;Load comparator bits
ANDLW    0xC0       ;Mask comparator bits
IORWF    FLAG_REG,F ;Store bits in flag register
MOVLW    0x03       ;Init comparator mode
MOVWF    CMCON      ;CM<2:0> = 011
BSF      STATUS,RP0 ;Select Bank1
MOVLW    0x07       ;Initialize data direction
MOVWF    TRISA      ;Set RA<2:0> as inputs
                    ;RA<4:3> as outputs
                    ;TRISA<7:5> always read '0'
BCF      STATUS,RP0 ;Select Bank 0
CALL     DELAY10    ;10µs delay
MOVF     CMCON,F    ;Read CMCON to end change condition
BCF      PIR1,CMIF  ;Clear pending interrupts
BSF      STATUS,RP0 ;Select Bank 1
BSF      PIE1,CMIE  ;Enable comparator interrupts
BCF      STATUS,RP0 ;Select Bank 0
BSF      INTCON,PEIE ;Enable peripheral interrupts
BSF      INTCON,GIE ;Global interrupt enable
```

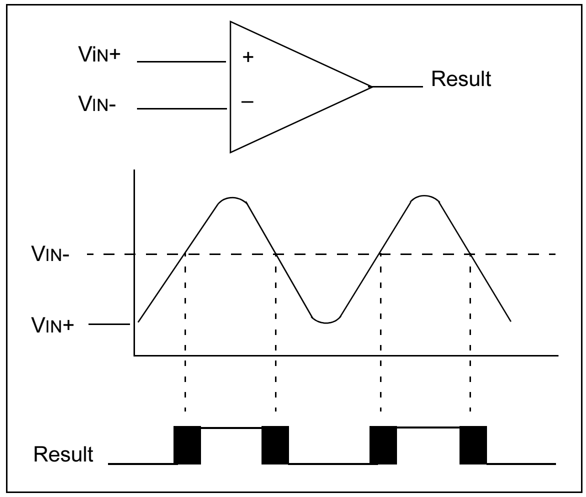
9.2 Comparator Operation

A single comparator is shown in Figure 9-2 along with the relationship between the analog input levels and the digital output. When the analog input at $V_{IN}+$ is less than the analog input $V_{IN}-$, the output of the comparator is a digital low level. When the analog input at $V_{IN}+$ is greater than the analog input $V_{IN}-$, the output of the comparator is a digital high level. The shaded areas of the output of the comparator in Figure 9-2 represent the uncertainty due to input offsets and response time.

9.3 Comparator Reference

An external or internal reference signal may be used depending on the Comparator Operating mode. The analog signal that is present at $V_{IN}-$ is compared to the signal at $V_{IN}+$, and the digital output of the comparator is adjusted accordingly (Figure 9-2).

FIGURE 9-2: SINGLE COMPARATOR



9.3.1 EXTERNAL REFERENCE SIGNAL

When external voltage references are used, the comparator module can be configured to have the comparators operate from the same or different reference sources. However, threshold detector applications may require the same reference. The reference signal must be between V_{SS} and V_{DD}, and can be applied to either pin of the comparator(s).

9.3.2 INTERNAL REFERENCE SIGNAL

The Comparator module also allows the selection of an internally generated voltage reference for the comparators. Section 10.0, Voltage Reference Manual, contains a detailed description of the Voltage Reference module that provides this signal. The internal reference signal is used when the comparators are in mode CM<2:0>=010 (Figure 9-1). In this mode, the internal voltage reference is applied to the $V_{IN}+$ pin of both comparators.

9.4 Comparator Response Time

Response time is the minimum time, after selecting a new reference voltage or input source, before the comparator output is ensured to have a valid level. If the internal reference is changed, the maximum delay of the internal voltage reference must be considered when using the comparator outputs. Otherwise the maximum delay of the comparators should be used (Table 17-1).

12.0 UNIVERSAL SYNCHRONOUS/ ASYNCHRONOUS RECEIVER/ TRANSMITTER (USART) MODULE

The Universal Synchronous Asynchronous Receiver Transmitter (USART) module is one of the two serial I/O modules. (USART is also known as a Serial Communications Interface or SCI). The USART can be configured as a full duplex asynchronous system that can communicate with peripheral devices such as CRT terminals and personal computers, or it can be configured as a half duplex synchronous system that can communicate with peripheral devices such as A/D or D/A integrated circuits, Serial EEPROMs etc.

The USART can be configured in the following modes:

- Asynchronous (full duplex)
- Synchronous - Master (half duplex)
- Synchronous - Slave (half duplex)

Bit SPEN (RCSTA<7>), and bits TRISB<2:1>, have to be set in order to configure pins RB2/TX/CK and RB1/RX/DT as the Universal Synchronous Asynchronous Receiver Transmitter.

REGISTER 12-1: TXSTA: TRANSMIT STATUS AND CONTROL REGISTER (ADDRESS: 98h)

R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R-1	R/W-0
CSRC	TX9	TXEN	SYNC	—	BRGH	TRMT	TX9D
bit 7							bit 0

bit 7 **CSRC**: Clock Source Select bit
Asynchronous mode
Don’t care
Synchronous mode
1 = Master mode (Clock generated internally from BRG)
0 = Slave mode (Clock from external source)

bit 6 **TX9**: 9-bit Transmit Enable bit
1 = Selects 9-bit transmission
0 = Selects 8-bit transmission

bit 5 **TXEN**: Transmit Enable bit(1)
1 = Transmit enabled
0 = Transmit disabled

bit 4 **SYNC**: USART Mode Select bit
1 = Synchronous mode
0 = Asynchronous mode

bit 3 **Unimplemented:** Read as '0'

bit 2 **BRGH**: High Baud Rate Select bit
Asynchronous mode
1 = High speed
0 = Low speed
Synchronous mode
Unused in this mode

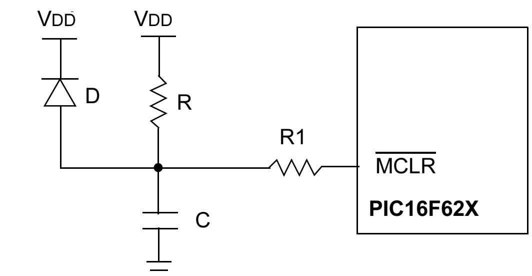
bit 1 **TRMT**: Transmit Shift Register STATUS bit
1 = TSR empty
0 = TSR full

bit 0 **TX9D**: 9th bit of transmit data. Can be PARITY bit.

Note 1: SREN/CREN overrides TXEN in SYNC mode.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	’1’ = Bit is set	’0’ = Bit is cleared	x = Bit is unknown

FIGURE 14-11: EXTERNAL POWER-ON RESET CIRCUIT (FOR SLOW VDD POWER-UP)

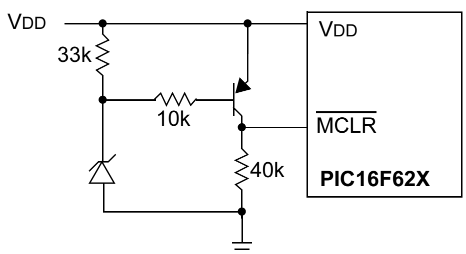


Note 1: External Power-on Reset circuit is required only if VDD power-up slope is too slow. The diode D helps discharge the capacitor quickly when VDD powers down.

2: R < 40 kΩ is recommended to make sure that voltage drop across R does not violate the device's electrical specification.

3: R1 = 100Ω to 1 kΩ will limit any current flowing into MCLR from external capacitor C in the event of MCLR/VPP pin breakdown due to Electrostatic Discharge (ESD) or Electrical Overstress (EOS).

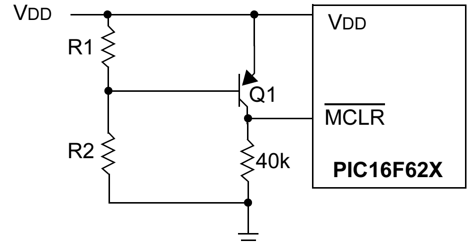
FIGURE 14-12: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 1



Note 1: This circuit will activate RESET when VDD goes below (Vz + 0.7V) where Vz = Zener voltage.

2: Internal Brown-out Detect Reset circuitry should be disabled when using this circuit.

FIGURE 14-13: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 2



Note 1: This Brown-out Circuit is less expensive, albeit less accurate. Transistor Q1 turns off when VDD is below a certain level such that:

$$V_{DD} \times \frac{R1}{R1 + R2} = 0.7V$$

2: Internal Brown-out Detect Reset should be disabled when using this circuit.

3: Resistors should be adjusted for the characteristics of the transistor.

TABLE 14-9: SUMMARY OF INTERRUPT REGISTERS

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR Reset	Value on all other RESETS(1)
0Bh	INTCON	GIE	PEIE	T0IE	INTE	RBIE	T0IF	INTF	RBIF	0000 000x	0000 000u
0Ch	PIR1	EEIF	CMIF	RCIF	TXIF	—	CCP1IF	TMR2IF	TMR1IF	0000 -000	0000 -000
8Ch	PIE1	EEIE	CMIE	RCIE	TXIE	—	CCP1IE	TMR2IE	TMR1IE	0000 -000	0000 -000

Note 1: Other (non Power-up) Resets include $\overline{\text{MCLR}}$ Reset, Brown-out Detect Reset and Watchdog Timer Reset during normal operation.

14.7 Context Saving During Interrupts

During an interrupt, only the return PC value is saved on the stack. Typically, users may wish to save key registers during an interrupt (e.g., W register and STATUS register). This will have to be implemented in software.

Example 14-2 stores and restores the STATUS and W registers. The user register, W_TEMP, must be defined in a common memory location (i.e., W_TEMP is defined at 0x70 in Bank 0 and is therefore, accessible at 0xF0, 0x17 and 0xIFD). The Example 14-2:

- Stores the W register
- Stores the STATUS register
- Executes the ISR code
- Restores the STATUS (and bank select bit register)
- Restores the W register

EXAMPLE 14-2: SAVING THE STATUS AND W REGISTERS IN RAM

```
MOVWF   W_TEMP          ;copy W to temp register,
                        could be in either bank
SWAPF   STATUS,W        ;swap status to be saved
                        into W
BCF     STATUS,RP0      ;change to bank 0 regardless
                        of current bank
MOVWF   STATUS_TEMP     ;save status to bank 0
                        register
        :
        : (ISR)
        :
SWAPF   STATUS_TEMP,W   ;swap STATUS_TEMP register
                        into W, sets bank to origi-
                        nal
                        state
MOVWF   STATUS          ;move W into STATUS register
SWAPF   W_TEMP,F        ;swap W_TEMP
SWAPF   W_TEMP,W        ;swap W_TEMP into W
```

14.8 Watchdog Timer (WDT)

The Watchdog Timer is a free running on-chip RC oscillator which does not require any external components. This RC oscillator is separate from the ER oscillator of the CLKIN pin. That means that the WDT will run, even if the clock on the OSC1 and OSC2 pins of the device has been stopped, for example, by execution of a `SLEEP` instruction. During normal operation, a WDT timeout generates a device RESET. If the device is in SLEEP mode, a WDT timeout causes the device to wake-up and continue with normal operation. The WDT can be permanently disabled by programming the configuration bit WDTE as clear (Section 14.1).

14.8.1 WDT PERIOD

The WDT has a nominal timeout period of 18 ms (with no prescaler). The timeout periods vary with temperature, V_{DD} and process variations from part to part (see DC specs). If longer timeout periods are desired, a postscaler with a division ratio of up to 1:128 can be assigned to the WDT under software control by writing to the OPTION register. Thus, timeout periods up to 2.3 seconds can be realized.

The `CLRWDT` and `SLEEP` instructions clear the WDT and the postscaler, if assigned to the WDT, and prevent it from timing out and generating a device RESET.

The $\overline{\text{TO}}$ bit in the STATUS register will be cleared upon a Watchdog Timer timeout.

14.8.2 WDT PROGRAMMING CONSIDERATIONS

It should also be taken in account that under worst case conditions (V_{DD} = Min., Temperature = Max., max. WDT prescaler), it may take several seconds before a WDT timeout occurs.

MOVWF	Move W to f			
Syntax:	[*label*] MOVWF f			
Operands:	$0 \leq f \leq 127$			
Operation:	(W) → (f)			
Status Affected:	None			
Encoding:	00	0000	1fff	ffff
Description:	Move data from W register to register 'f'.			
Words:	1			
Cycles:	1			
Example	`MOVWF REG1` Before Instruction REG1 = 0xFF W = 0x4F After Instruction REG1 = 0x4F W = 0x4F			

OPTION	Load Option Register			
Syntax:	[*label*] OPTION			
Operands:	None			
Operation:	(W) → OPTION			
Status Affected:	None			
Encoding:	00	0000	0110	0010
Description:	The contents of the W register are loaded in the OPTION register. This instruction is supported for code compatibility with PIC16C5X products. Since OPTION is a readable/writable register, the user can directly address it. Using only register instruction such as `MOVWF`.			
Words:	1			
Cycles:	1			
Example				

To maintain upward compatibility with future PICmicro® products, do not use this instruction.

NOP	No Operation			
Syntax:	[*label*] NOP			
Operands:	None			
Operation:	No operation			
Status Affected:	None			
Encoding:	00	0000	0xx0	0000
Description:	No operation.			
Words:	1			
Cycles:	1			
Example	`NOP`			

RETFIE	Return from Interrupt			
Syntax:	[*label*] RETFIE			
Operands:	None			
Operation:	TOS → PC, 1 → GIE			
Status Affected:	None			
Encoding:	00	0000	0000	1001
Description:	Return from Interrupt. Stack is POPed and Top of Stack (TOS) is loaded in the PC. Interrupts are enabled by setting Global Interrupt Enable bit, GIE (INTCON<7>). This is a two-cycle instruction.			
Words:	1			
Cycles:	2			
Example	`RETFIE` After Interrupt PC = TOS GIE = 1			

RRF — Rotate Right f through Carry

Syntax: [*label*] RRF f,d

Operands: $0 \le f \le 127$
$d \in [0,1]$

Operation: See description below

Status Affected: C

Encoding:

`00`	`1100`	`dfff`	`ffff`

Description: The contents of register 'f' are rotated one bit to the right through the Carry Flag. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'.

Words: 1

Cycles: 1

Example: `RRF REG1, 0`

Before Instruction
REG1 = `1110 0110`
C = `0`

After Instruction
REG1 = `1110 0110`
W = `0111 0011`
C = `0`

SLEEP

Syntax: [*label*] SLEEP

Operands: None

Operation: 00h → WDT,
0 → WDT prescaler,
1 → $\overline{TO}$,
0 → $\overline{PD}$

Status Affected: $\overline{TO}$, $\overline{PD}$

Encoding:

`00`	`0000`	`0110`	`0011`

Description: The power-down STATUS bit, $\overline{PD}$ is cleared. Timeout STATUS bit, $\overline{TO}$ is set. Watchdog Timer and its prescaler are cleared.
The processor is put into SLEEP mode with the oscillator stopped. See Section 14.9 for more details.

Words: 1

Cycles: 1

Example: `SLEEP`

SUBLW — Subtract W from Literal

Syntax: [*label*] SUBLW k

Operands: $0 \le k \le 255$

Operation: k - (W) → (W)

Status Affected: C, DC, Z

Encoding:

`11`	`110x`	`kkkk`	`kkkk`

Description: The W register is subtracted (2's complement method) from the eight bit literal 'k'. The result is placed in the W register.

Words: 1

Cycles: 1

Example 1: `SUBLW 0x02`

Before Instruction
W = 1
C = ?

After Instruction
W = 1
C = 1; result is positive

Example 2: Before Instruction
W = 2
C = ?

After Instruction
W = 0
C = 1; result is zero

Example 3: Before Instruction
W = 3
C = ?

After Instruction
W = 0xFF
C = 0; result is negative

16.19 PICDEM 18R PIC18C601/801 Demonstration Board

The PICDEM 18R demonstration board serves to assist development of the PIC18C601/801 family of Microchip microcontrollers. It provides hardware implementation of both 8-bit Multiplexed/De-multiplexed and 16-bit Memory modes. The board includes 2 Mb external FLASH memory and 128 Kb SRAM memory, as well as serial EEPROM, allowing access to the wide range of memory types supported by the PIC18C601/801.

16.20 PICDEM LIN PIC16C43X Demonstration Board

The powerful LIN hardware and software kit includes a series of boards and three PICmicro microcontrollers. The small footprint PIC16C432 and PIC16C433 are used as slaves in the LIN communication and feature on-board LIN transceivers. A PIC16F874 FLASH microcontroller serves as the master. All three microcontrollers are programmed with firmware to provide LIN bus communication.

16.21 PICDEM USB PIC16C7X5 Demonstration Board

The PICDEM USB Demonstration Board shows off the capabilities of the PIC16C745 and PIC16C765 USB microcontrollers. This board provides the basis for future USB products.

16.22 Evaluation and Programming Tools

In addition to the PICDEM series of circuits, Microchip has a line of evaluation kits and demonstration software for these products.

- KEELOQ evaluation and programming tools for Microchip's HCS Secure Data Products
- CAN developers kit for automotive network applications
- Analog design boards and filter design software
- PowerSmart battery charging evaluation/ calibration kits
- IrDA® development kit
- microID development and RFLab™ development software
- SEEVAL® designer kit for memory evaluation and endurance calculations
- PICDEM MSC demo boards for Switching mode power supply, high power IR driver, delta sigma ADC, and flow rate sensor

Check the Microchip web page and the latest Product Line Card for the complete list of demonstration and evaluation kits.

TABLE 16-1: DEVELOPMENT TOOLS FROM MICROCHIP

		PIC12CXXX	PIC12FXXX	PIC14000	PIC16C5X	PIC16C6X	PIC16CXXX	PIC16C43X	PIC16F62X	PIC16C7X	PIC16C7XX	PIC16C7X5	PIC16C8X	PIC16F8XX	PIC16C9XX	PIC17C4X	PIC17C7XX	PIC18CXX2	PI18CX01	PIC18FXXX	dsPIC30F
Software Tools	MPLAB Integrated Development Environment	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓		✓	
	MPLAB C17 C Compiler															✓	✓				
	MPLAB C18 C Compiler																	✓		✓	
	MPASM Assembler/ MPLINK Object Linker	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓	✓		✓	
	MPLAB C30 C Compiler																				✓
	MPLAB ASM30 Assembler/Linker/Librarian																				✓
Emulators	MPLAB ICE 2000 In-Circuit Emulator	✓	✓	✓	✓	✓	✓	✓	✓**	✓	✓	✓	✓	✓	✓	✓	✓	✓		✓	
	MPLAB ICE 4000 In-Circuit Emulator	✓			✓	✓	✓			✓	✓		✓		✓		✓	✓	✓	✓	✓
Debugger	MPLAB ICD 2 In-Circuit Debugger		✓			✓*				✓*				✓					✓	✓	✓
Programmers	PICSTART Plus Entry Level Development Programmer	✓	✓	✓	✓	✓	✓	✓	✓**	✓	✓	✓	✓	✓	✓	✓	✓	✓		✓	
	PRO MATE II Universal Device Programmer	✓	✓	✓	✓	✓	✓	✓	✓**	✓	✓	✓	✓	✓	✓	✓	✓	✓		✓	
Demo Boards and Eval Kits	PICDEM 1 Demonstration Board				✓		✓			✓†			✓			✓					
	PICDEM.net Demonstration Board																	✓			
	PICDEM 2 Plus Demonstration Board					✓†				✓†								✓		✓	
	PICDEM 3 Demonstration Board														✓						
	PICDEM 14A Demonstration Board			✓																	
	PICDEM 17 Demonstration Board																✓				
	PICDEM 18R Demonstration Board																		✓		
	PICDEM LIN Demonstration Board							✓						✓							
	PICDEM USB Demonstration Board											✓		✓							

* Contact the Microchip web site at www.microchip.com for information on how to use the MPLAB ICD In-Circuit Debugger (DV164001) with PIC16C62, 63, 64, 65, 72, 73, 74, 76, 77.
** Contact Microchip Technology Inc. for availability date.
† Development tool is available on select devices.

TABLE 17-3: DC CHARACTERISTICS: PIC16F62X, PIC16LF62X

DC Characteristics			Standard Operating Conditions (unless otherwise stated)				
Parameter No.	**Sym**	**Characteristic**	**Min**	**Typ†**	**Max**	**Units**	**Conditions**
		Data EEPROM Memory					
D120	ED	Endurance	1M*	10M	—	E/W	25°C at 5V
D121	VDRW	VDD for read/write	VMIN	—	5.5	V	VMIN = Minimum operating voltage
D122	TDEW	Erase/Write cycle time	—	4	8*	ms	
		Program FLASH Memory					
D130	EP	Endurance	1000*	10000	—	E/W	
D131	VPR	VDD for read	Vmin	—	5.5	V	VMIN = Minimum operating voltage
D132	VPEW	VDD for erase/write	4.5	—	5.5	V	
D133	TPEW	Erase/Write cycle time	—	4	8*	ms	

* These parameters are characterized but not tested.

† Data in “Typ” column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

17.4 Timing Diagrams and Specifications

FIGURE 17-6: EXTERNAL CLOCK TIMING

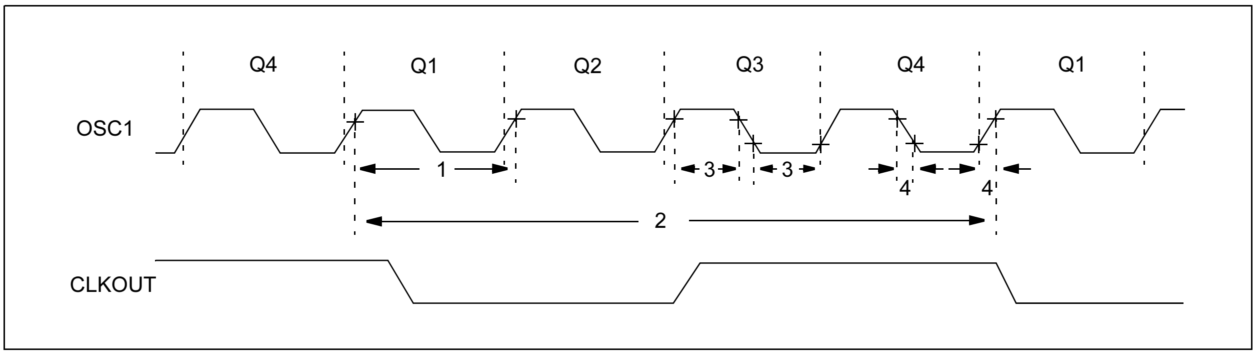
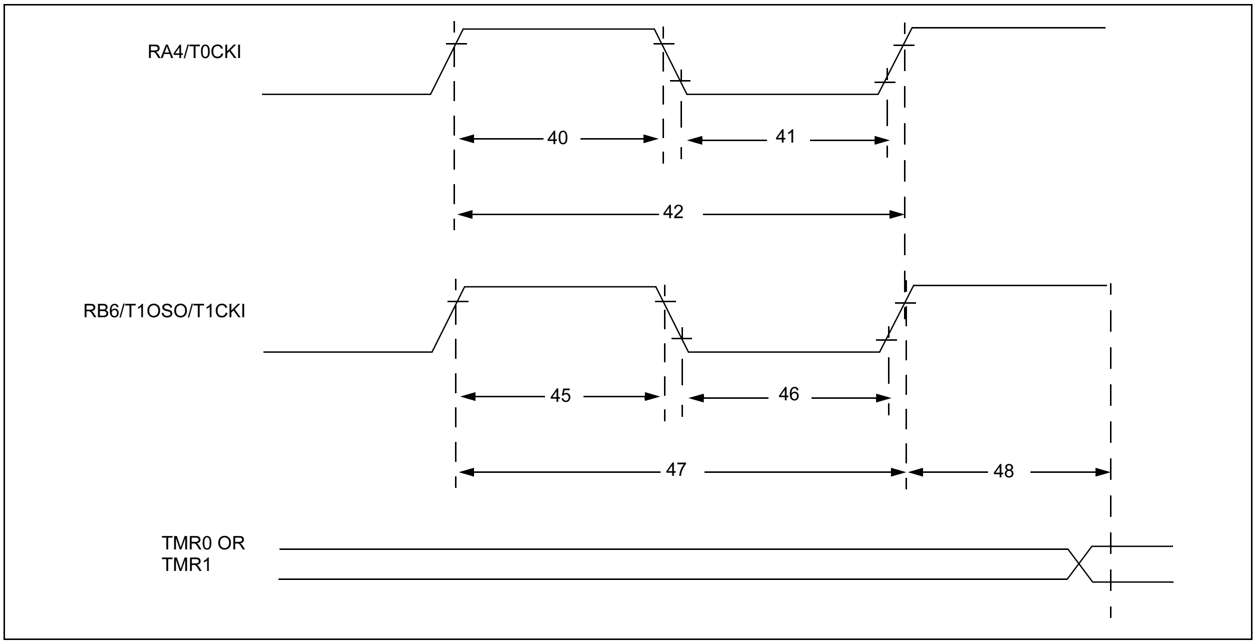


FIGURE 17-10: TIMER0 AND TIMER1 EXTERNAL CLOCK TIMINGS



Note:	The graphs and tables provided in this section are for design guidance and are not tested.

FIGURE 18-8: TYPICAL INTERNAL RC FOSC VS VDD TEMPERATURE (-40 TO 125°C) INTERNAL 4 MHz OSCILLATOR

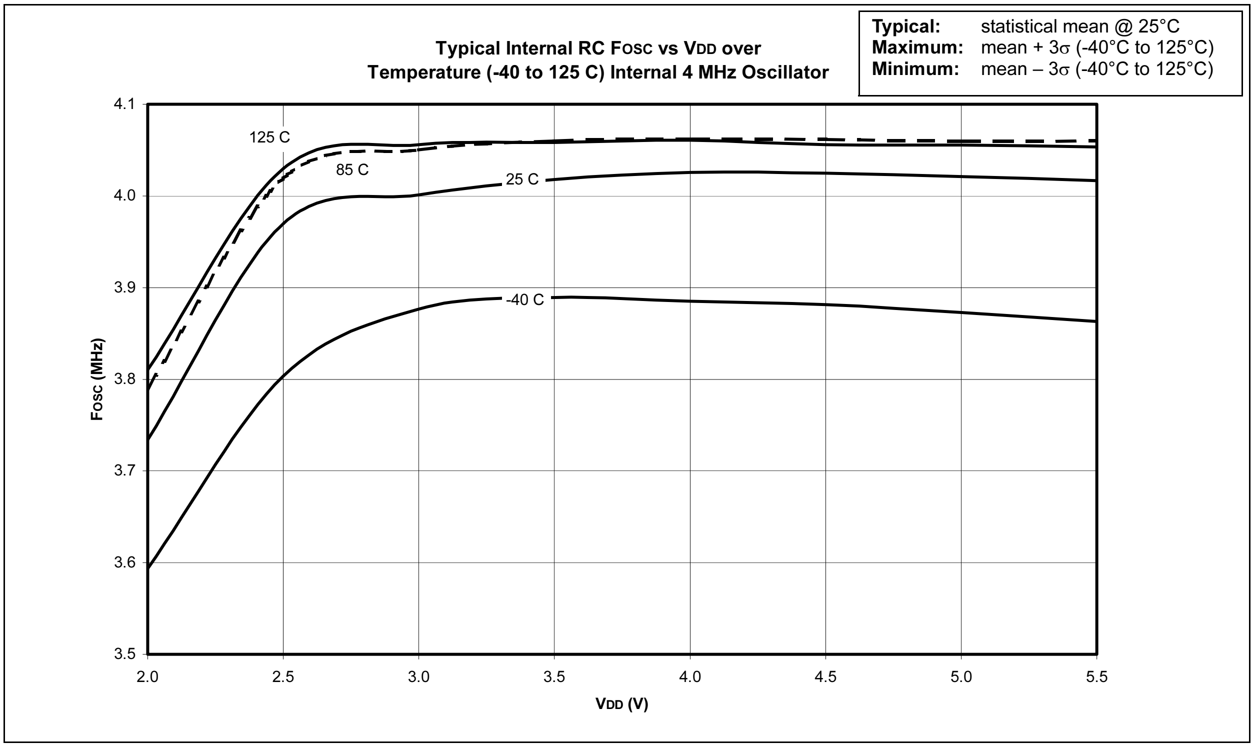
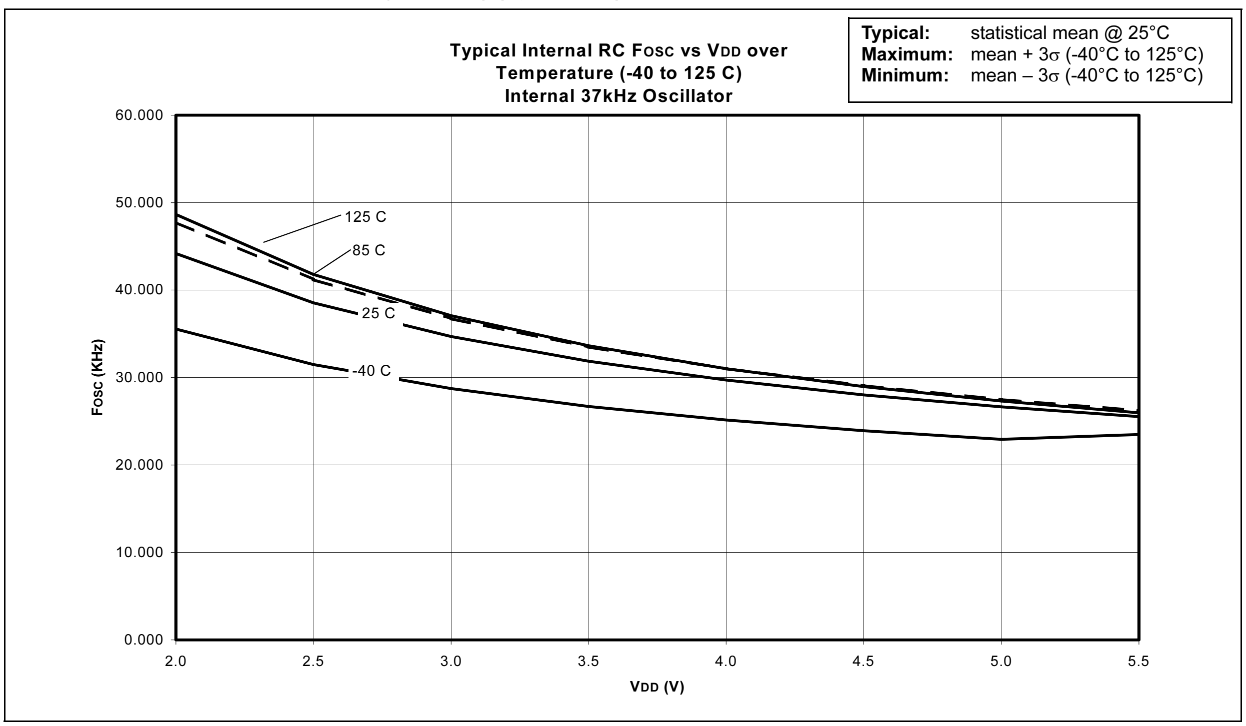
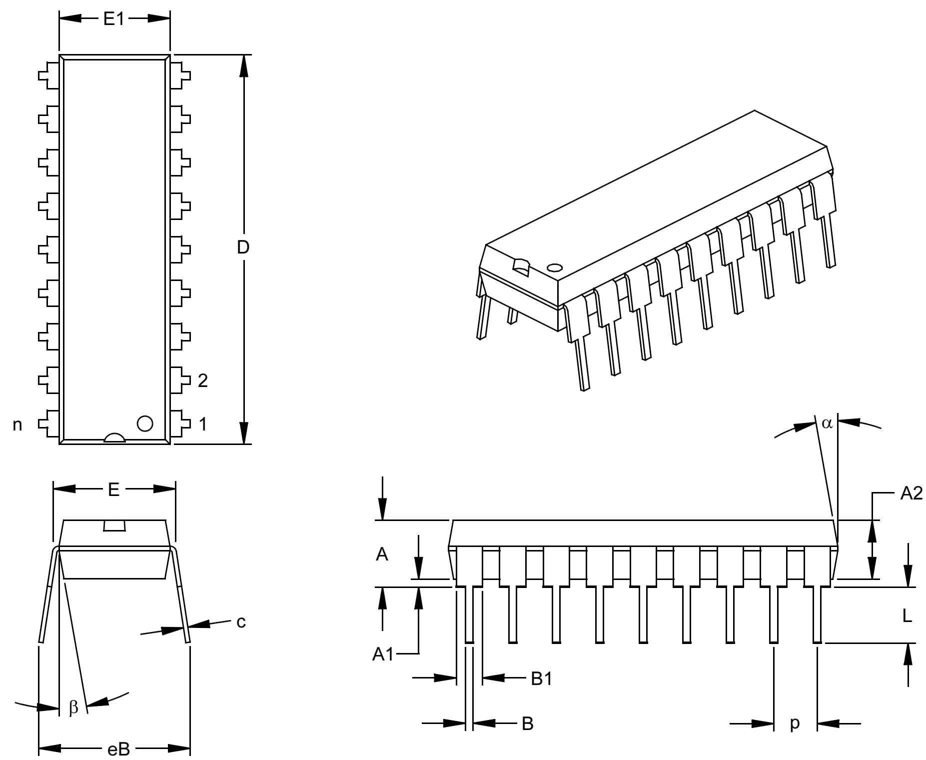


FIGURE 18-9: TYPICAL INTERNAL RC FOSC VS VDD OVER TEMPERATURE (-40 TO 125°C) INTERNAL 37 kHz OSCILLATOR



K04-007 18-Lead Plastic Dual In-line (P) – 300 mil



Units		INCHES*			MILLIMETERS		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		18			18	
Pitch	p		.100			2.54	
Top to Seating Plane	A	.140	.155	.170	3.56	3.94	4.32
Molded Package Thickness	A2	.115	.130	.145	2.92	3.30	3.68
Base to Seating Plane	A1	.015			0.38		
Shoulder to Shoulder Width	E	.300	.313	.325	7.62	7.94	8.26
Molded Package Width	E1	.240	.250	.260	6.10	6.35	6.60
Overall Length	D	.890	.898	.905	22.61	22.80	22.99
Tip to Seating Plane	L	.125	.130	.135	3.18	3.30	3.43
Lead Thickness	c	.008	.012	.015	0.20	0.29	0.38
Upper Lead Width	B1	.045	.058	.070	1.14	1.46	1.78
Lower Lead Width	B	.014	.018	.022	0.36	0.46	0.56
Overall Row Spacing §	eB	.310	.370	.430	7.87	9.40	10.92
Mold Draft Angle Top	α	5	10	15	5	10	15
Mold Draft Angle Bottom	β	5	10	15	5	10	15

* Controlling Parameter
§ Significant Characteristic

Notes:
Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010” (0.254mm) per side.
JEDEC Equivalent: MS-001
Drawing No. C04-007

 Preliminary

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